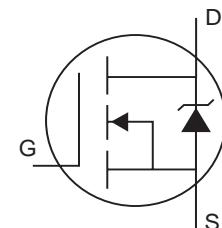
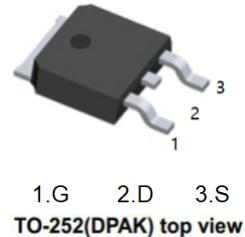


**Description**

- Ultra Low On-Resistance
- Fast Switching
- Fully Avalanche Rated
- Lead-Free
- $V_{DS}(V) = 50V$
- $I_D = 27A$  ( $V_{GS} = 10V$ )
- $R_{DS(ON)} < 45m\Omega$  ( $V_{GS} = 10V$ )

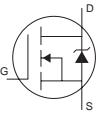
**Absolute Maximum Ratings**

	Parameter	Max.	Units
$I_D @ T_C = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	27⑤	A
$I_D @ T_C = 100^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	19	
$I_{DM}$	Pulsed Drain Current ①⑦	100	
$P_D @ T_C = 25^\circ C$	Power Dissipation	68	W
	Linear Derating Factor	0.45	W/°C
$V_{GS}$	Gate-to-Source Voltage	$\pm 20$	V
$E_{AS}$	Single Pulse Avalanche Energy ②⑦	65	mJ
$I_{AR}$	Avalanche Current ①⑦	16	A
$E_{AR}$	Repetitive Avalanche Energy ①⑦	6.8	mJ
$dv/dt$	Peak Diode Recovery $dv/dt$ ③	5.0	V/ns
$T_J$ $T_{STG}$	Operating Junction and Storage Temperature Range	-55 to + 175	°C
	Soldering Temperature, for 10 seconds	300 (1.6mm from case )	

**Thermal Resistance**

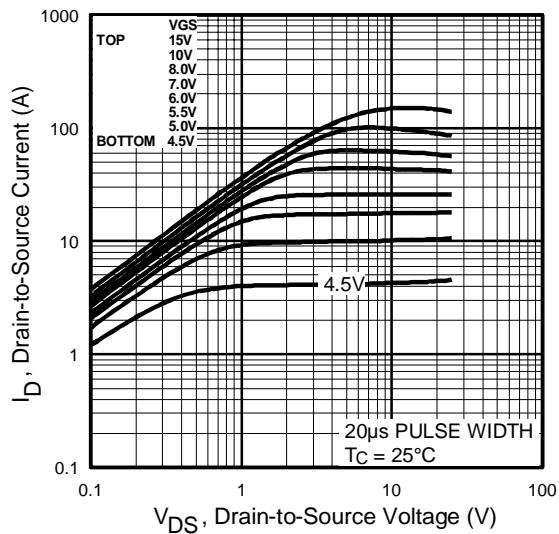
	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case		2.2	°C/W
$R_{\theta JA}$	Junction-to-Ambient (PCB mount) **		50	
$R_{\theta JA}$	Junction-to-Ambient		110	

**Electrical Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

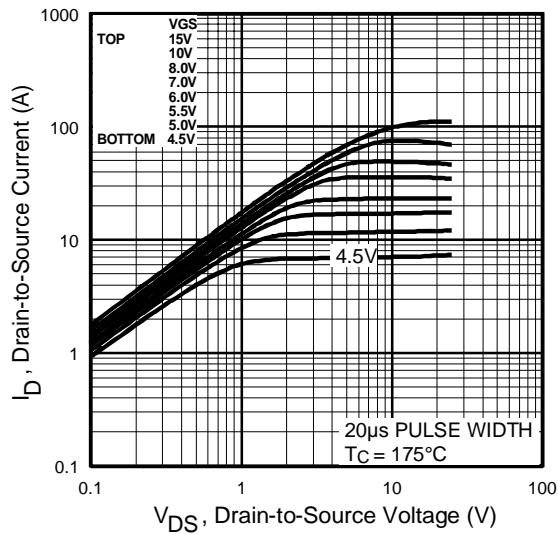
	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(\text{BR})\text{DSS}}$	Drain-to-Source Breakdown Voltage	55			V	$V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$
$\Delta V_{(\text{BR})\text{DSS}}/\Delta T_J$	Breakdown Voltage Temp. Coefficient		0.052		V/ $^\circ\text{C}$	Reference to $25^\circ\text{C}, I_D = 1\text{mA}$
$R_{DS(\text{on})}$	Static Drain-to-Source On-Resistance		45			$V_{GS} = 10\text{V}, I_D = 16\text{A}$ ④
$V_{GS(\text{th})}$	Gate Threshold Voltage	2.0		4.0	V	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$
$g_{fs}$	Forward Transconductance	6.5			S	$V_{DS} = 25\text{V}, I_D = 16\text{A}$ ⑦
$I_{DSS}$	Drain-to-Source Leakage Current		25		$\mu\text{A}$	$V_{DS} = 55\text{V}, V_{GS} = 0\text{V}$
			250			$V_{DS} = 44\text{V}, V_{GS} = 0\text{V}, T_J = 150^\circ\text{C}$
$I_{GSS}$	Gate-to-Source Forward Leakage		100		$\text{nA}$	$V_{GS} = 20\text{V}$
	Gate-to-Source Reverse Leakage		-100			$V_{GS} = -20\text{V}$
$Q_g$	Total Gate Charge		34			$I_D = 16\text{A}$
$Q_{gs}$	Gate-to-Source Charge		6.8		nC	$V_{DS} = 44\text{V}$
$Q_{gd}$	Gate-to-Drain ("Miller") Charge		14			$V_{GS} = 10\text{V}$ , See Fig. 6 and 13 ④ ⑦
$t_{d(on)}$	Turn-On Delay Time		7.0			$V_{DD} = 28\text{V}$
$t_r$	Rise Time		49		ns	$I_D = 16\text{A}$
$t_{d(off)}$	Turn-Off Delay Time		31			$R_G = 18\Omega$
$t_f$	Fall Time		40			$R_D = 1.8\Omega$ , See Fig. 10 ④ ⑦
$L_D$	Internal Drain Inductance		4.5		nH	Between lead, 6mm (0.25in.) from package and center of die contact ⑥
$L_S$	Internal Source Inductance		7.5			
$C_{iss}$	Input Capacitance	700				$V_{GS} = 0\text{V}$
$C_{oss}$	Output Capacitance	240			pF	$V_{DS} = 25\text{V}$
$C_{rss}$	Reverse Transfer Capacitance	100				$f = 1.0\text{MHz}$ , See Fig. 5 ⑦
	Parameter	Min.	Typ.	Max.	Units	Conditions
$I_S$	Continuous Source Current (Body Diode)			27 ③	A	MOSFET symbol showing the integral reverse p-n junction diode. 
$I_{SM}$	Pulsed Source Current (Body Diode) ① ⑦			100		
$V_{SD}$	Diode Forward Voltage			1.6	V	$T_J = 25^\circ\text{C}, I_S = 16\text{A}, V_{GS} = 0\text{V}$ ④
$t_{rr}$	Reverse Recovery Time		57	86	ns	$T_J = 25^\circ\text{C}, I_F = 16\text{A}$
$Q_{rr}$	Reverse Recovery Charge		130	200	nC	$dI/dt = 100\text{A}/\mu\text{s}$ ④ ⑦
$t_{on}$	Forward Turn-On Time					Intrinsic turn-on time is negligible (turn-on is dominated by $L_S + L_D$ )

**Notes:**

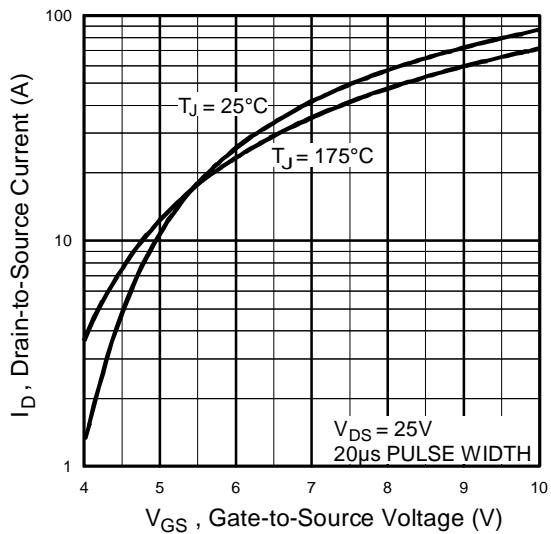
- ① Repetitive rating; pulse width limited by max. junction temperature. ( See fig. 11 )
- ②  $V_{DD} = 25\text{V}$ , starting  $T_J = 25^\circ\text{C}$ ,  $L = 410\mu\text{H}$ ,  $R_G = 25\Omega$ ,  $I_{AS} = 16\text{A}$ . (See Figure 12)
- ③  $I_{SD} \leq 16\text{A}$ ,  $di/dt \leq 420\text{A}/\mu\text{s}$ ,  $V_{DD} \leq V_{(\text{BR})\text{DSS}}$ ,  $T_J \leq 175^\circ\text{C}$
- ④ Pulse width  $\leq 300\mu\text{s}$ ; duty cycle  $\leq 2\%$
- ⑤ Calculated continuous current based on maximum allowable junction temperature; Package limitation current = 20A



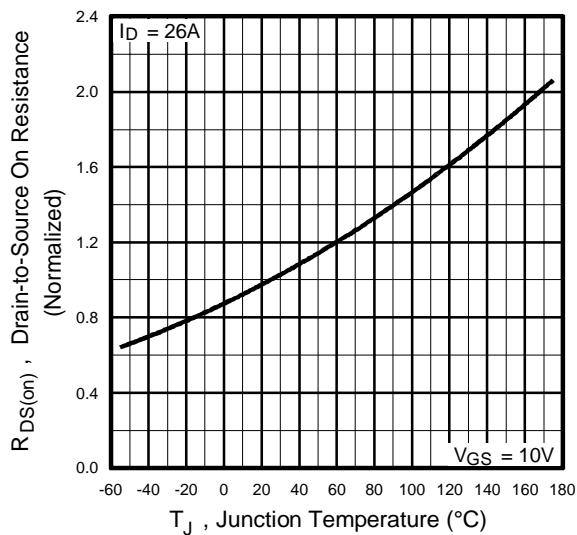
**Fig 1.** Typical Output Characteristics



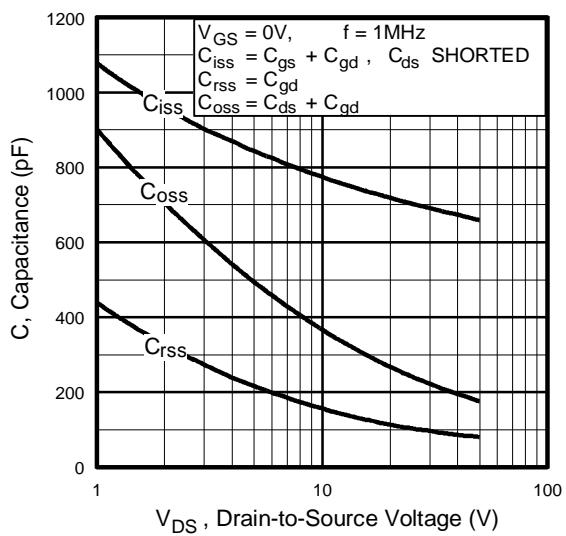
**Fig 2.** Typical Output Characteristics



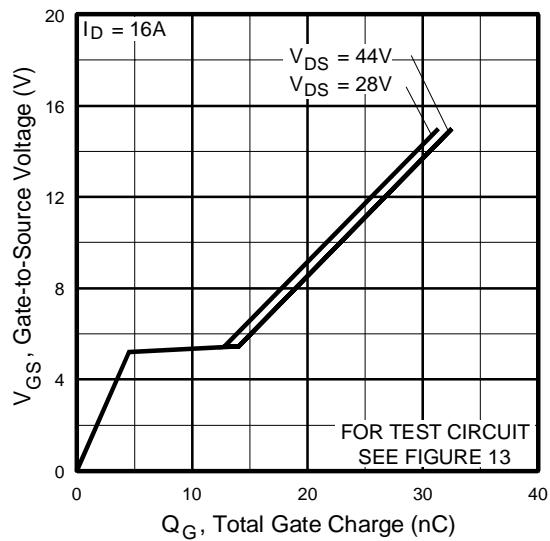
**Fig 3.** Typical Transfer Characteristics



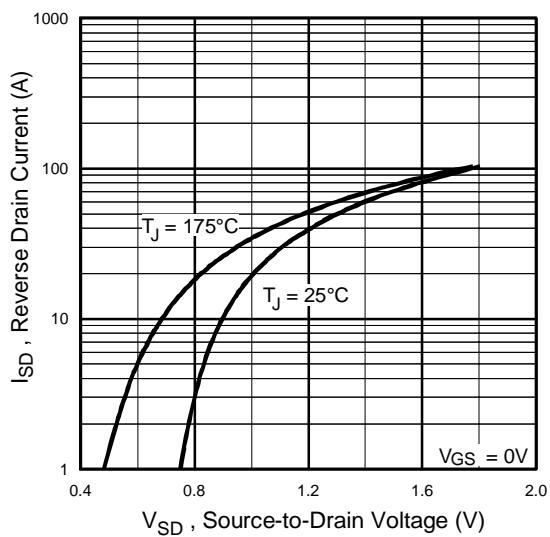
**Fig 4.** Normalized On-Resistance Vs. Temperature



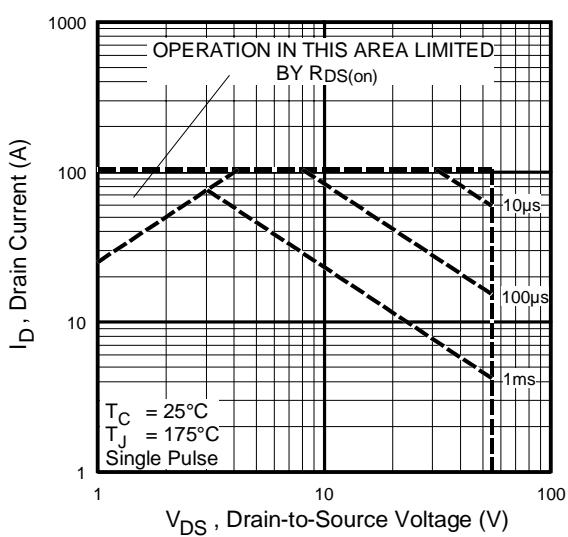
**Fig 5.** Typical Capacitance Vs.  
Drain-to-Source Voltage



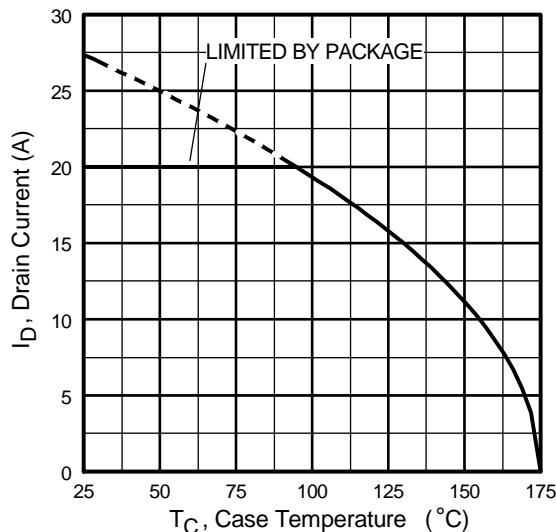
**Fig 6.** Typical Gate Charge Vs.  
Gate-to-Source Voltage



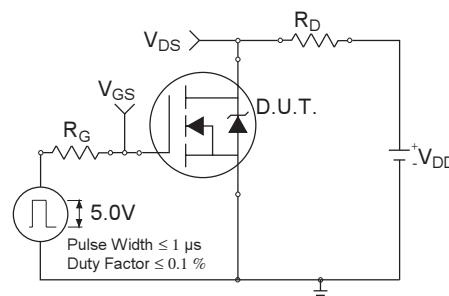
**Fig 7.** Typical Source-Drain Diode  
Forward Voltage



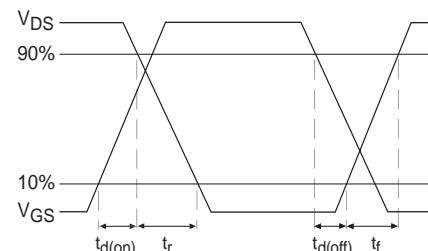
**Fig 8.** Maximum Safe Operating Area



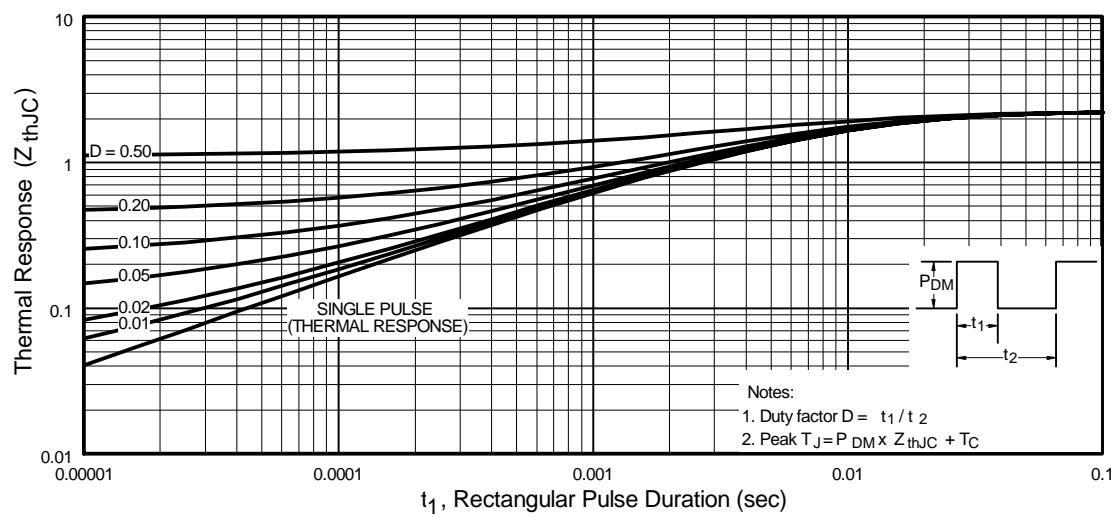
**Fig 9.** Maximum Drain Current Vs.  
Case Temperature



**Fig 10a.** Switching Time Test Circuit



**Fig 10b.** Switching Time Waveforms



**Fig 11.** Maximum Effective Transient Thermal Impedance, Junction-to-Case

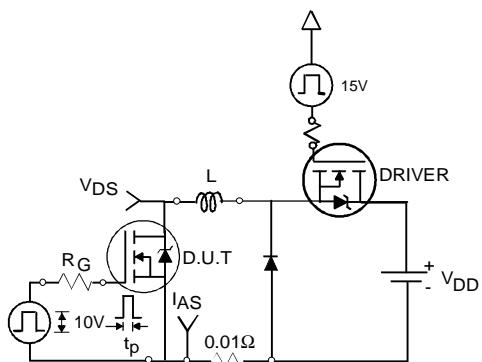


Fig 12a. Unclamped Inductive Test Circuit

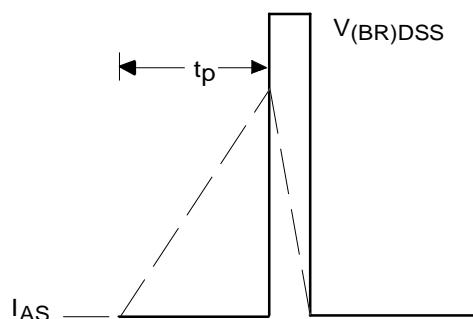


Fig 12b. Unclamped Inductive Waveforms

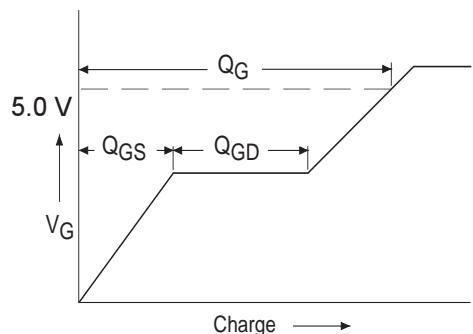


Fig 13a. Basic Gate Charge Waveform

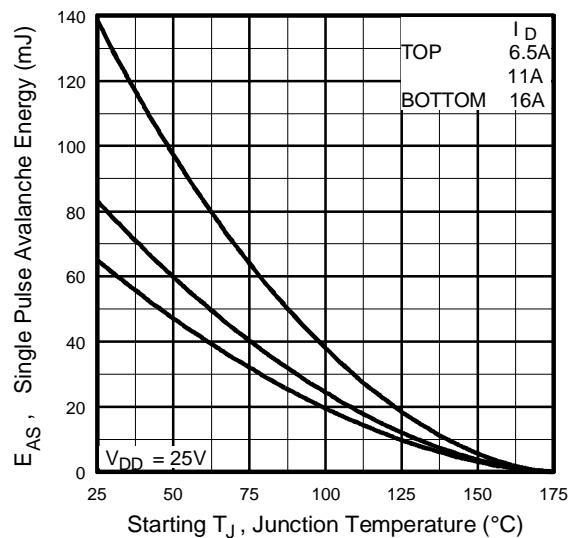


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

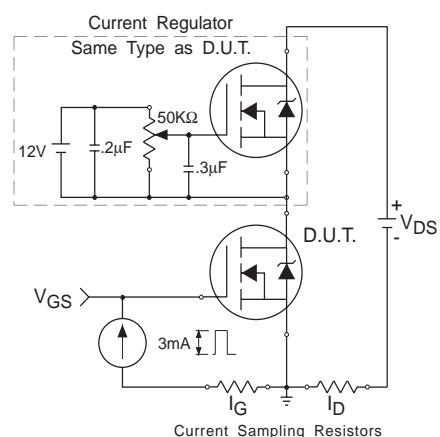
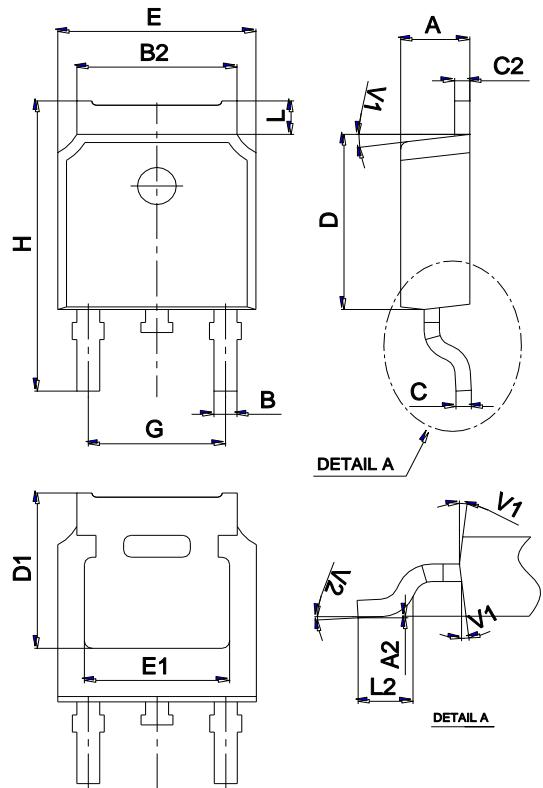
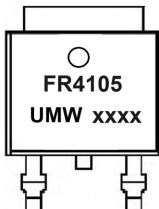


Fig 13b. Gate Charge Test Circuit

**Package Mechanical Data TO-252**

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.10		2.50	0.083		0.098
A2	0		0.10	0		0.004
B	0.66		0.86	0.026		0.034
B2	5.18		5.48	0.202		0.216
C	0.40		0.60	0.016		0.024
C2	0.44		0.58	0.017		0.023
D	5.90		6.30	0.232		0.248
D1	5.30REF			0.209REF		
E	6.40		6.80	0.252		0.268
E1	4.63			0.182		
G	4.47		4.67	0.176		0.184
H	9.50		10.70	0.374		0.421
L	1.09		1.21	0.043		0.048
L2	1.35		1.65	0.053		0.065
V1		7°			7°	
V2	0°		6°	0°		6°

**Marking****Ordering information**

Order code	Package	Baseqty	Deliverymode
UMW IRFR4105TR	TO-252	2500	Tape and reel

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[MCQ7328-TP](#) [SSM3J143TU,LXHF](#) [DMN12M3UCA6-7](#) [PJMF280N65E1\\_T0\\_00201](#) [PJMF380N65E1\\_T0\\_00201](#)  
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